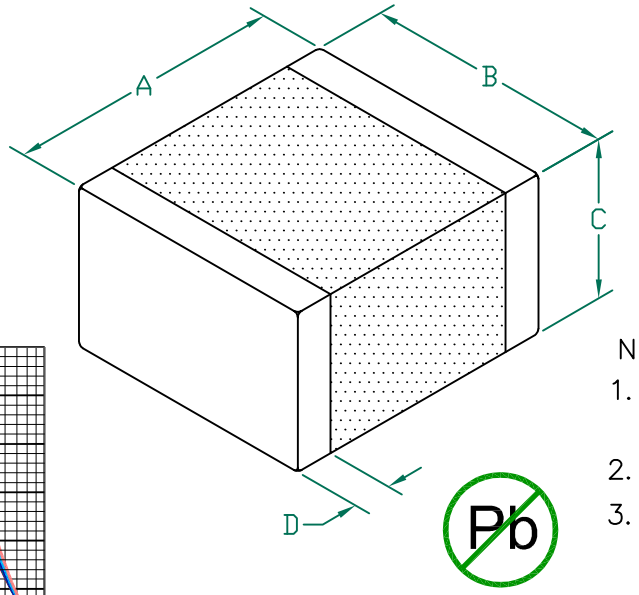
HI2220R301R-10

UNCONTROLLED DOCUMENT

PHYSICAL DIMENSIONS:

A	5.59 [.220]	±	0.51 [.020]
B	5.08 [.200]	±	0.25 [.010]
C	3.20 [.126]	±	0.25 [.010]
D	0.76 [.030]	±	0.25 [.010]



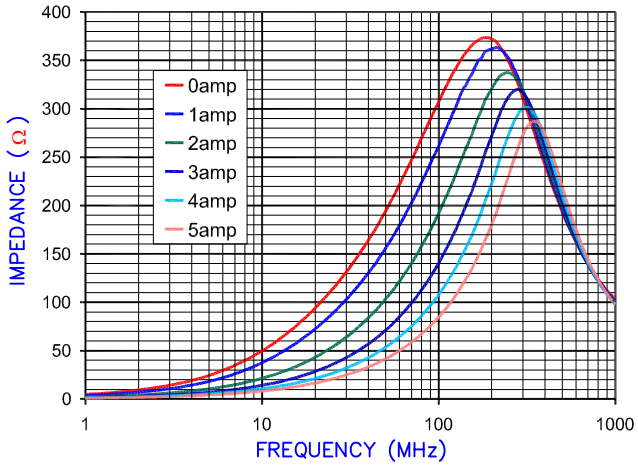
ELECTRICAL CHARACTERISTICS:

	Z @ 100MHz (Ω)	DCR (Ω)	Rated Current
Nominal	300		
Minimum	225		
Maximum	375	0.020	5000 mA

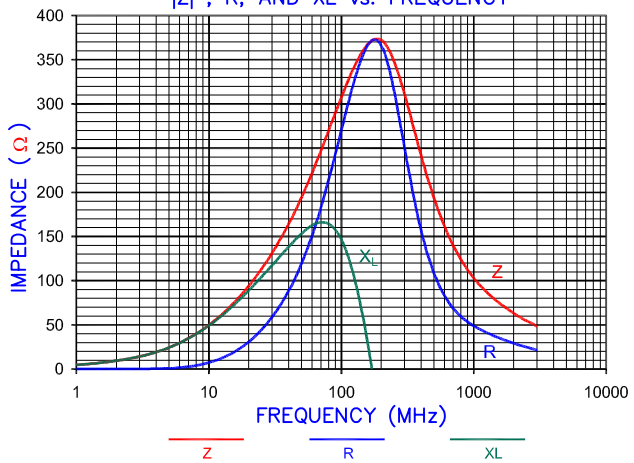
NOTES: UNLESS OTHERWISE SPECIFIED

1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 13" REELS, 2,000 PCS/REEL.
2. TERMINATION FINISH IS 100% TIN.
3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.

Z vs. FREQUENCY
IMPEDANCE UNDER DC BIAS

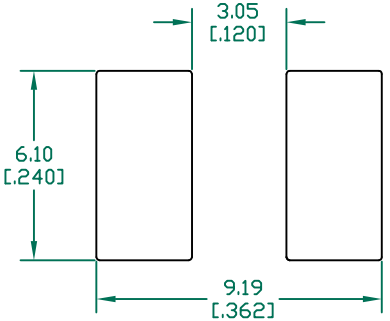


|Z| , R, AND XL vs. FREQUENCY



AGILENT E4991A RF Impedance/Material Analyzer
HP 16092A Test Fixture. TEST REF. 3185

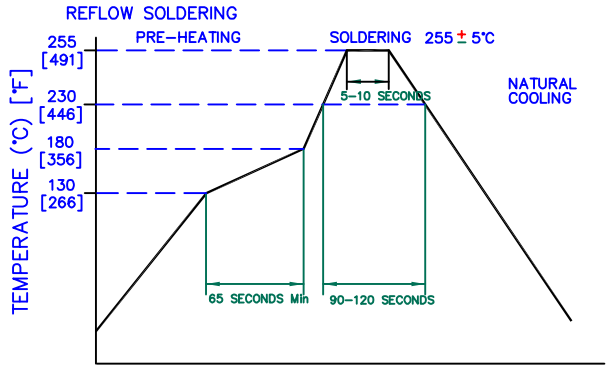
LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [0.030] to this dimension)

RECOMMENDED SOLDERING CONDITIONS

REFLOW SOLDERING



RoHS 2002/95/EC

DIMENSIONS ARE IN mm [INCHES].

REV	DESCRIPTION	DATE	INT
C	UPDATE COMPANY LOGO AND REFLOW	12/26/12	QU
B	UPDATE COMPANY LOGO ADD ROHS	01/28/08	JRK
A	ORIGINAL DRAFT	04/03/04	TMB

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Laird TECHNOLOGIES

PROJECT/PART NUMBER:	REV	PART TYPE:	DRAWN BY:
HI2220R301R-10	C	CO-FIRE	TMB

DATE:	SCALE:	SHEET:
04/03/04	NTS	2 of 2

CAD # HI2220R301R-10-C TOOL # –

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